

OPTIMOM FAMILY

Turnkey Imaging Modules for Instant Integration





Accelerate your development and focus on your true added value with Optimom[™], a new range of turnkey imaging modules that can be instantly integrated into embedded vision systems.

Optimom modules directly interface with your vision platform using a MIPI CSI-2 interface. This flexible solution offers various key features: multi focus or 5D vision (2D image + 3D depth data). A lens customization service is also available.



To enable straightforward validation and prototyping, evaluation and development kits combined with specific drivers are available, as well as 3D vision SDK's.

MIPI CSI-2 Interface Ideal for embedded processing boards Standard FFC/FPC connector for plug-and-play connection



Immediate Integration Using the Development Kit Including connectivity boards and Linux drivers



Global Shutter Proprietary CMOS image sensor

Low noise. Low power. On-the-fly configuration updates



A Single R&D Effort All Optimom versions share the same footprint Full software compatibility



2D + 3D Capability For 3D vision at short distances without occlusion Factory calibrated. 5D SDK for Qualcomm or Nvidia platforms



Multi Focus For sharp images at any distance Response time < 1ms. Easy control through I²C





IMAGING MODULES 1.5M, 2M, 5D B&W and Color

OPTIMOM 5D



CUSTOMER CHALLENGES

3D vision system simplification at lower cost

3D vision at short distance

Easy interface with embedded vision platforms

BENEFITS OF THE OPTIMOM 5D

No additional lighting needed Ready to integrate; already focused & calibrated

No occlusion limitations

MIPI connector interface Drivers and processing SDK available for selected platforms

PARAMETERS	OPTIMOM 5D MONO (Topaz5D Sensor Inside)			
Resolution (pixels)	2D image: 1920 (H) x 1080 (V) 3D depth map processing: 480 x 270			
Working distance range (cm)	30 to 130			
Focus point (cm)	50 cm; fixed focus			
FoV (°)	48° Diagonal			
3D Calibration	Provided by Teledyne e2v			
Readout noise (Topaz5D sensor) (e- @ 25°C, 10 bits)	3.5			
Max frame rate (fps)	2D image: 65 fps (10 bits) 3D depth map: depends on processing platform			
Operating temperature (°C)	-40°C / +85°C (at sensor level)			
Power consumption (max frame rate) (mW)	< 220 mW; depending on fps			
Mipi connector	34-pins; 0.5 mm pitch			
Dimension (mm)	25 (L) x 25 (I) x 25 (H)			
Options	Color; lens customization (M12 mount)			

TELEDYNE

OPTIMOM MULTI FOCUS



Optimom M-F focus at 10 cm

Optimom M-F focus at 40 cm

Optimom M-F focus at 100 cm

CUSTOMER CHALLENGES

Addressing opto-mechanical factors, including the lens' focal point and depth of field

Seamless interfacing with embedded vision platforms

Accelerating time-to-market Offering a flexible solution with standardized hardware

BENEFITS OF THE OPTIMOM MULTI FOCUS

Multi focus/auto focus capability due to the MEMS integration which provides an enlarged depth of field

MIPI connector interface

Drivers available for selected SoC processors

Easy integration of hardware Full access to sensor settings; the same design for all versions of the Optimom module

PARAMETERS	OPTIMOM 2D MULTI FOCUS (Topaz Sensor Inside)			
Resolution (pixels)	2M: 1920 (H) x 1080 (V) 1.5M: 1920 (H) x 800 (V)			
Working distance range (cm)	10 cm to infinity			
FoV (°)	2M: 45° (H) x 26° (V) 1.5M: 45° (H) x 20° (V)			
Distortion (%)	<3.6			
Focus response time (ms)	<1; with possibility of focus adjustment frame by frame			
Readout noise (Topaz sensor) (e- @ 25°C, 10 bits)	3.5			
Max frame rate (fps)	2M: 65 fps (10 bits) to 100 fps (8 bits) 1.5M: 85 fps (10 bits) to 130 fps (8 bits)			
Operating temperature (°C)	[-20 ; +85]			
Power consumption (max frame rate) (mW)	< 220 mW			
Mipi connector	34-pins; 0.5 mm pitch			
Dimension (mm)	25 (L) x 25 (I) x 14,4 (H)			
Options	No lens; fixed focus lens (5.9 mm; F/4.0); Color lens customization (M12 mount)			

TELEDYNE

Evaluation Kit



THE PERFECT SOLUTION FOR COMPLETE EVALUATION

The Evaluation Kit enables you to easily assess the electro-optical or 3D vision performance of any Optimom module using a laptop with a USB 3 interface. Its camera-like form factor is suitable for end-user demos and proof of concepts.

COMPREHENSIVE KIT INCLUDING:

- Evaluation camera kit
- Power supply
- Cabling (FFC, USB C, Hirose)
- Evaluation software

Order the module of your choice (separately), plug the FFC cable, and start evaluation immediately!

Development Kit

FOR FASTER DEVELOPMENT OF SYSTEM SOFTWARE

The Development Kit contains connectivity boards and drivers to enable any Optimom 1.5M or 2M module to be directly interfaced into your software environment.

COMPREHENSIVE KIT INCLUDING:

- Adapter board to various vision platforms (NVIDIA, NXP, QUALCOMM)
- All necessary FPC cables
- Module holder
- · Power supply
- Video4Linux drivers
- 5D SDK for 3D vision support available on selected SoC platforms and Windows computers

Contact us for more details on the supported hardware & software platforms.



ORDER CODES – OPTIMOM 5D		ORDER CODES – KITS (Suitable for	ORDER CODES – KITS (Suitable for all Optimom products)		
MONO 5D	COLOR 5D	Evaluation Kit	EV2E0MG01-U3000-U		
EV5M02MB-PM2F202-B	EV5M02MC-PM2F201-B	Development Kit NVIDIA, NXP	EV2DOMG01-FJAT11-U		

ORDER CODES	OPTIMOM 1.5M		OPTIMOM 2M		
	B&W 1.5M	COLOR 1.5M		B&W 2M	COLOR 2M
No lens	EV2M1M5B-PM2N000-B	EV2M1M5C-PM2N000-B		EV2M02MB-PM2N000-B	EV2M02MC-PM2N000-B
No lens with IR-cut filter	EV2M1M5B-PM2I000-B	EV2M1M5C-PM2l000-B		EV2M02MB-PM21000-B	EV2M02MC-PM21000-B
Fixed Focus lens	EV2M1M5B-PM2F000-B	EV2M1M5C-PM2F000-B		EV2M02MB-PM2F000-B	EV2M02MC-PM2F000-B
Multi-focus/Auto-focus lens	EV2M1M5B-PM2M000-B	EV2M1M5C-PM2M000-B		EV2M02MB-PM2M000-B	EV2M02MC-PM2M000-B

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